



RBO40-40G/T

Application Specific Discretes
A.S.D.TM

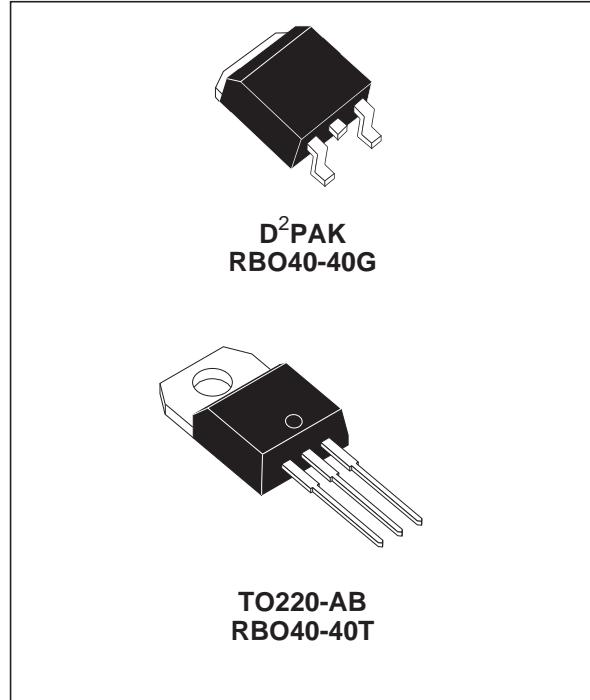
REVERSED BATTERY AND OVERVOLTAGE PROTECTION

FEATURES

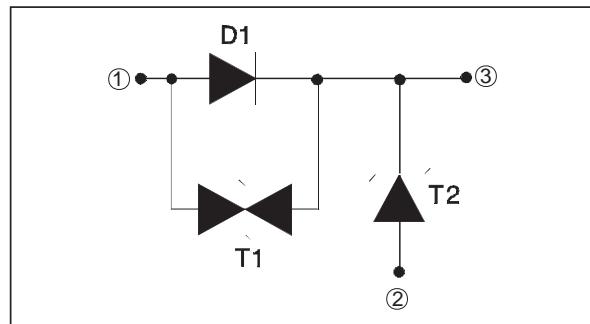
- PROTECTION AGAINST "LOAD DUMP" PULSE
- 40A DIODE TO GUARD AGAINST BATTERY REVERSAL
- MONOLITHIC STRUCTURE FOR GREATER RELIABILITY
- BREAKDOWN VOLTAGE : 24 V min.
- CLAMPING VOLTAGE : ± 40 V max.
- COMPLIANT WITH ISO / DTR 7637

DESCRIPTION

Designed to protect against battery reversal and load dump overvoltages in automotive applications, this monolithic component offers multiple functions in the same package :
D1 : reversed battery protection
T1 : clamping against negative overvoltages
T2 : Transil function against "load dump" effect.



FUNCTIONAL DIAGRAM



RBO40-40G / RBO40-40T

ABSOLUTE MAXIMUM RATINGS

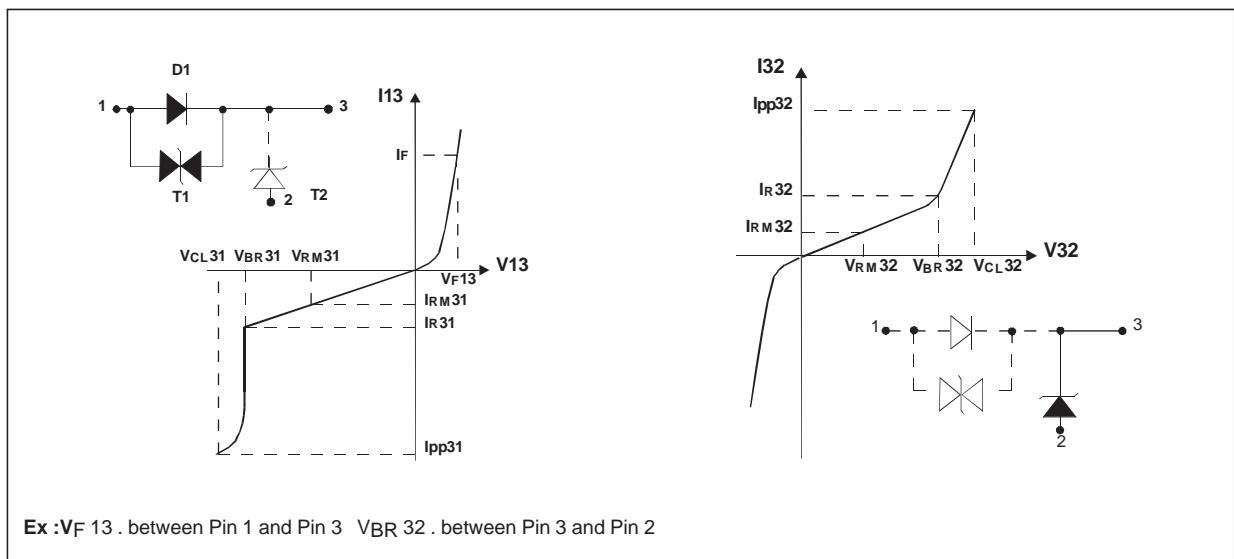
Symbol	Parameter	Value	Unit	
I_{FSM}	Non repetitive surge peak forward current (Diode D1)	tp = 10 ms	120	A
I_F	DC forward current (Diode D1)	Tc = 75°C	40	A
V_{PP}	Peak load dump voltage (see note 1and 2) 5 pulses (1 minute between each pulse)		80	V
P_{PP}	Peak pulse power between Input and Output (Transil T1) Tj initial = 25°C	10/1000 μ s	1500	W
T_{stg} T_j	Storage temperature range Maximum junction temperature	- 40 to + 150 150	°C	
T_L	Maximum lead temperature for soldering during 10 s at 4.5mm from case for TO220-AB	260	°C	

Note 1 : for a surge greater than the maximum value, the device will fail in short-circuit.

Note 2 : see Load Dump curves.

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit	
$R_{th} (j-c)$	Junction to case	RBO40-40G RBO40-40T	1.0 1.0	°C/W
$R_{th} (j-a)$	Junction to ambient	RBO40-40T	60	°C/W



Symbol	Parameter
V_{RM31}/V_{RM32}	Stand-off voltage Transil T1 / Transil T2.
V_{BR31}/V_{BR32}	Breakdown voltage Transil T1 / Transil T2.
I_{R31}/I_{R32}	Leakage current Transil T1 / Transil T2.
V_{CL31}/V_{CL32}	Clamping voltage Transil T1 / Transil T2.
V_{F13}	Forward voltage drop Diode D1.
I_{PP}	Peak pulse current.
αT	Temperature coefficient of V_{BR} .
C_{31}/C_{32}	Capacitance Transil T1 / Transil T2.
C_{13}	Capacitance of Diode D1

ELECTRICAL CHARACTERISTICS : DIODE D1 (- 40°C < T_{amb} < + 85°C)

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
V_{F13}	$I_F = 40 A$			1.9	V
V_{F13}	$I_F = 20A$			1.45	V
V_{F13}	$I_F = 1 A$			1	V
V_{F13}	$I_F = 100 mA$			0.95	V
C_{13}	$F = 1MHz \quad V_R = 0 V$		3000		pF

ELECTRICAL CHARACTERISTICS : TRANSIL T1 (- 40°C < T_{amb} < + 85°C)

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
V_{BR31}	$I_R = 1 mA$	22		35	V
V_{BR31}	$I_R = 1 mA, T_{amb} = 25^\circ C$	24		32	V
I_{RM31}	$V_{RM} = 20 V$			100	μA
I_{RM31}	$V_{RM} = 20 V, T_{amb} = 25^\circ C$			10	μA
V_{CL31}	$I_{PP} = 37.5A, T_j \text{ initial} = 25^\circ C$	10/1000 μs		40	V
αT	Temperature coefficient of V_{BR}			9	$10^{-4}/^\circ C$
C_{31}	$F = 1MHz \quad V_R = 0 V$		3000		pF

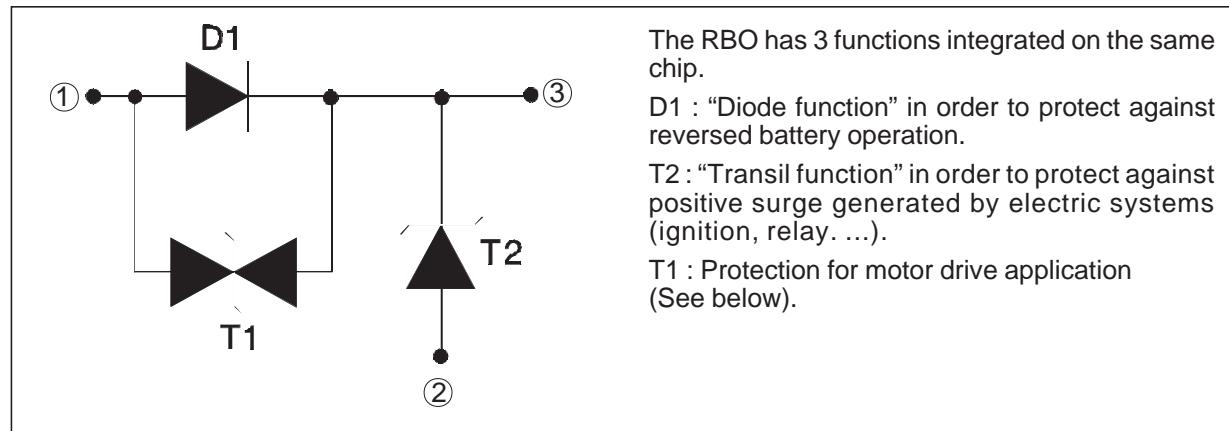
ELECTRICAL CHARACTERISTICS : TRANSIL T2 (- 40°C < T_{amb} < + 85°C)

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
V_{BR32}	$I_R = 1 mA$	22		35	V
V_{BR32}	$I_R = 1 mA, T_{amb} = 25^\circ C$	24		32	V
I_{RM32}	$V_{RM} = 20 V$			100	μA
I_{RM32}	$V_{RM} = 20 V, T_{amb} = 25^\circ C$			10	μA
V_{CL32}	$I_{PP} = 20 A \text{ (note 1)}$			40	V
αT	Temperature coefficient of V_{BR}			9	$10^{-4}/^\circ C$
C_{32}	$F = 1MHz \quad V_R = 0 V$		8000		pF

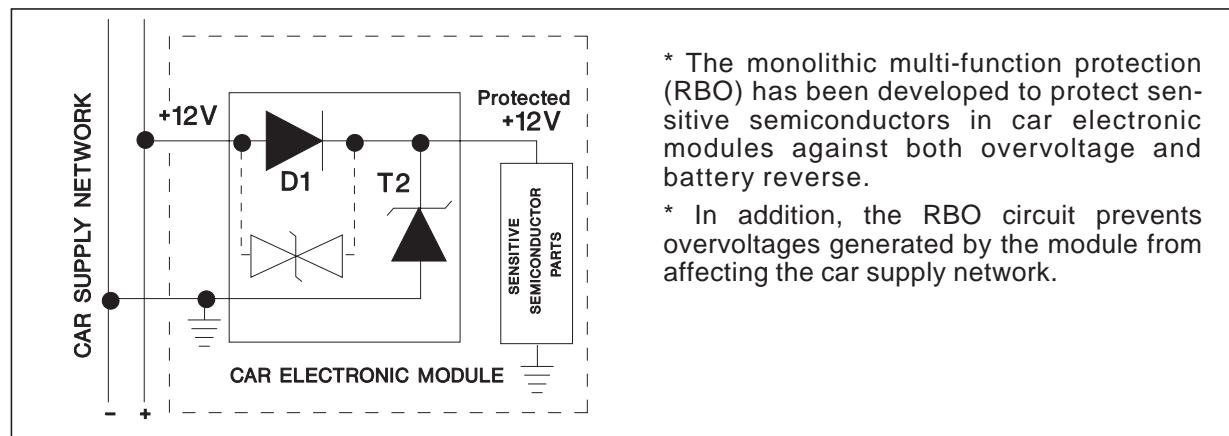
Note 1 : One pulse, see pulse definition in load dump test generator circuit.

RBO40-40G / RBO40-40T

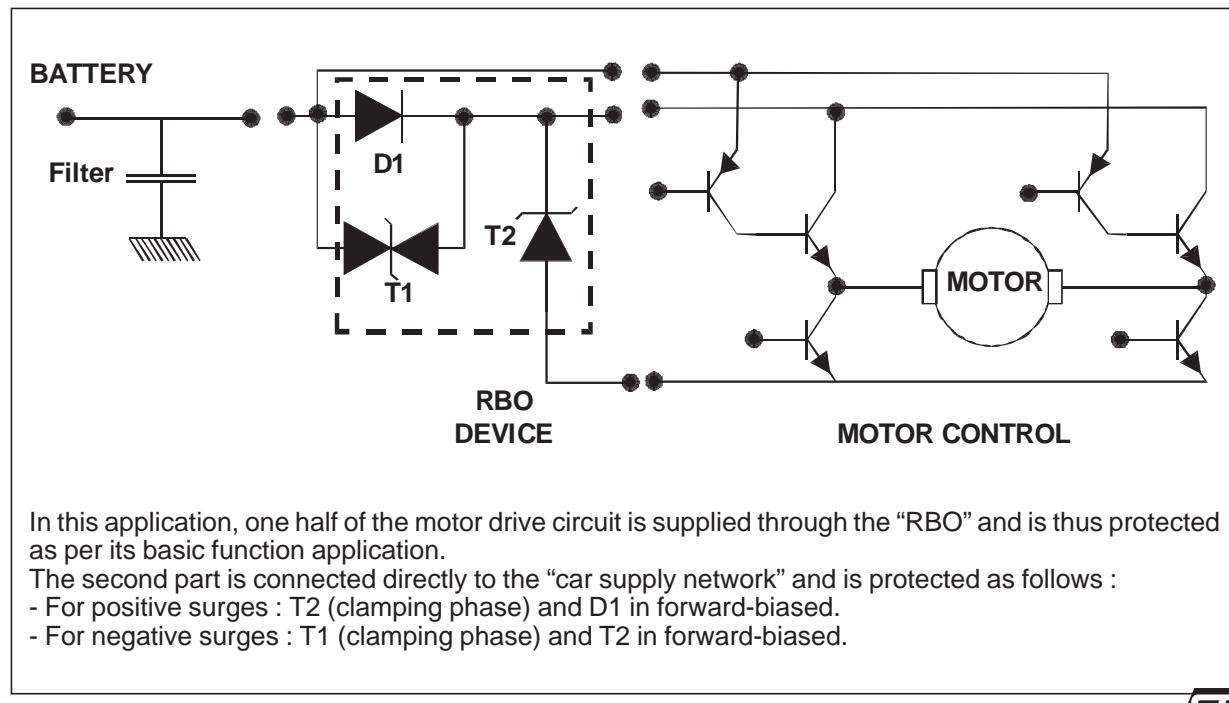
PRODUCT DESCRIPTION



BASIC APPLICATION



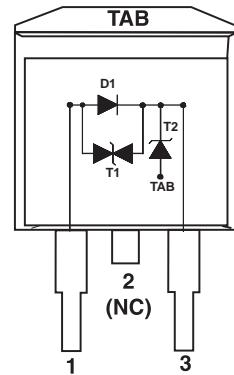
MOTOR DRIVER APPLICATION



PINOUT configuration in D²PAK :

- Input (1) : Pin 1
- Output (3) : Pin 3
- Gnd (2) : Connected to base Tab

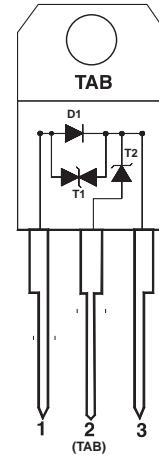
Marking : Logo, date code, RBO40-40G



PINOUT configuration in TO220AB :

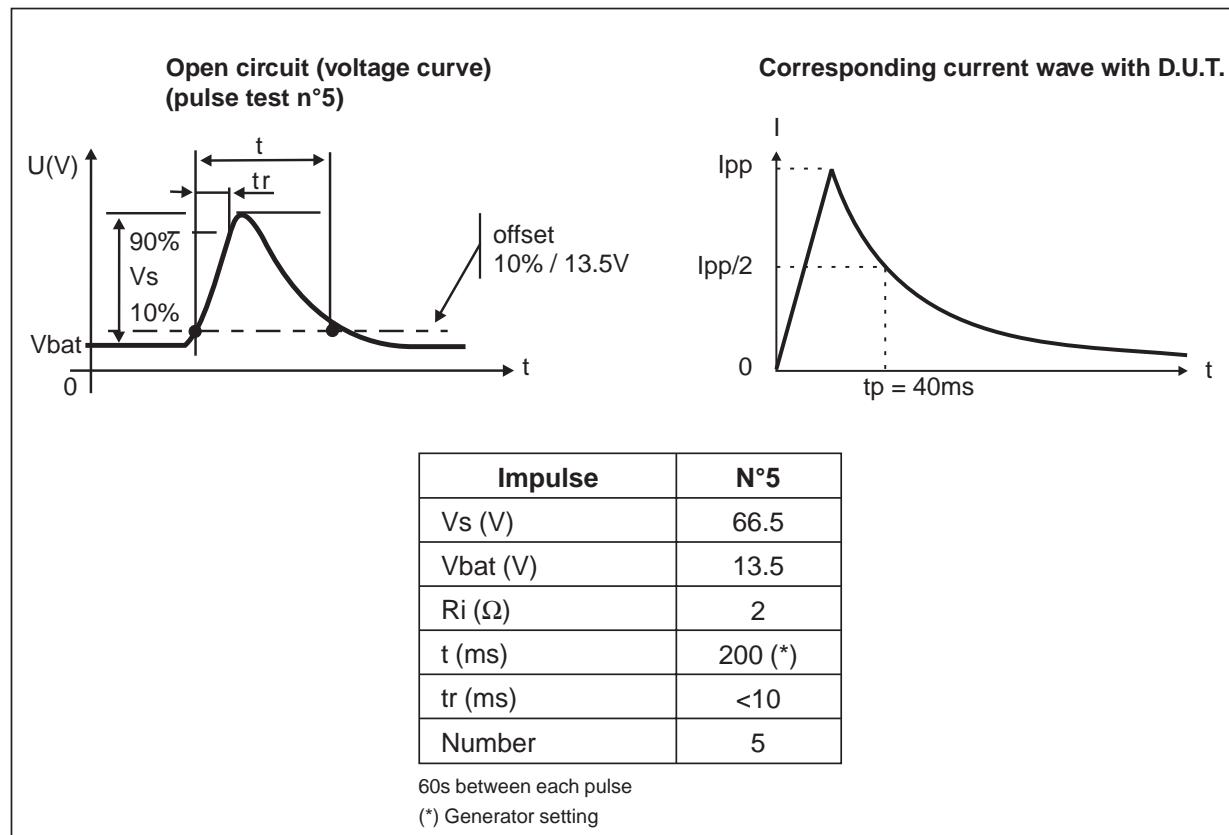
- Input (1) : Pin 1
- Output (3) : Pin 3
- GND (2) : Connected to base Tab

Marking : Logo, date code, RBO40-40T



RBO40-40G / RBO40-40T

LOAD DUMP TEST GENERATOR CIRCUIT (SCHAFFNER NSG 506 C). Issued from ISO / DTR 7637.



CALIBRATION METHOD FOR SCHAFFNER NSG 506 C

1) With open circuit (generator is in open circuit):

- calibrate Vs

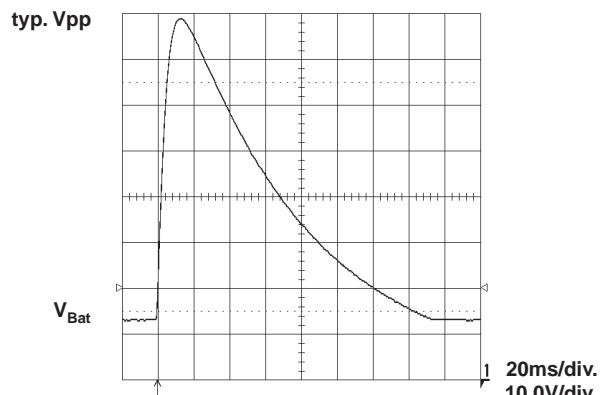
2) With short circuit (generator is in short circuit):

- calibrate Ri ($R_i = 2\Omega$)

3) With D.U.T.

- calibrate tp ($tp = 40ms @ I_{pp}/2$)

Typical Voltage curve (open circuit)



Typical Voltage and Current curve with D.U.T.

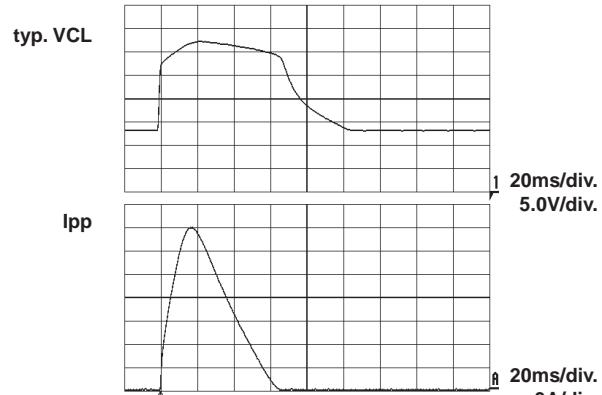


Fig. 1 : Peak pulse power versus exponential pulse duration (T_j initial = 85°C).

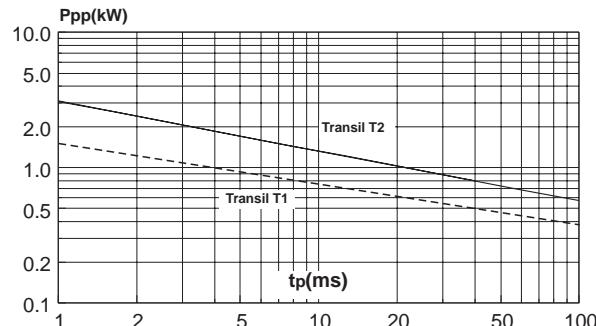


Fig. 2-1 : Clamping voltage versus peak pulse current (T_j initial = 85°C).

Exponential waveform $tp = 40$ ms and $tp = 1$ ms (TRANSIL T2).

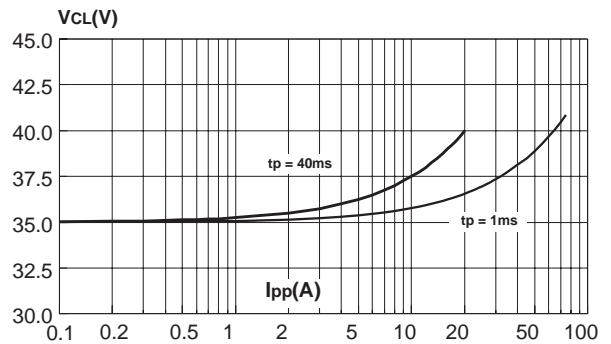


Fig. 2-2 : Clamping voltage versus peak pulse current (T_j initial = 85°C).

Exponential waveform $tp = 1$ ms and $tp = 20 \mu s$ (TRANSIL T1).

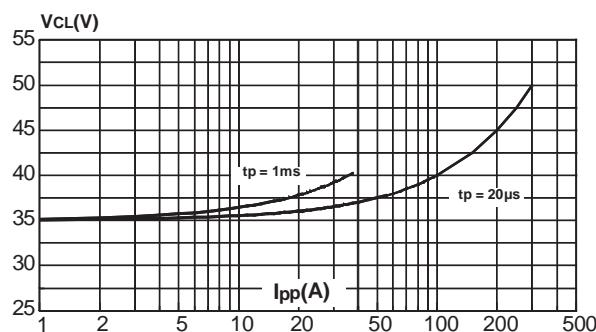
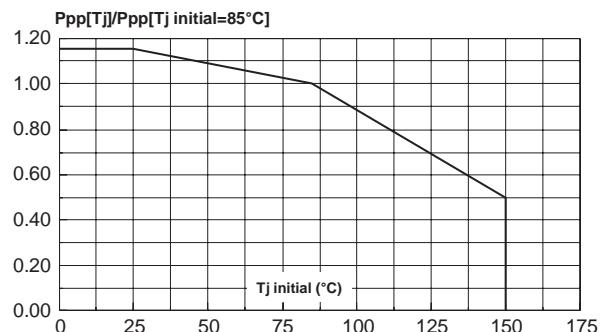


Fig. 3 : Relative variation of peak pulse power versus junction temperature.



RBO40-40G / RBO40-40T

Fig. 4 : Relative variation of thermal impedance junction to case versus pulse duration.

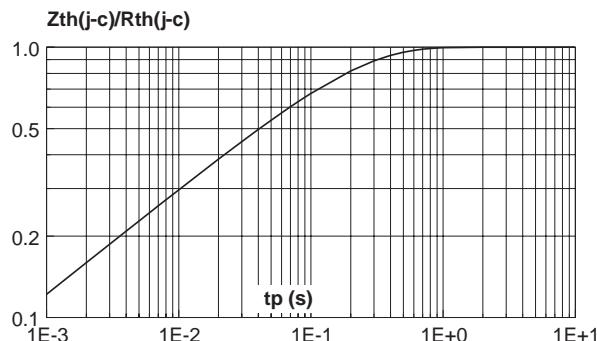


Fig. 5-1 : Peak forward voltage drop versus peak forward current (typical values) - (TRANSIL T2).

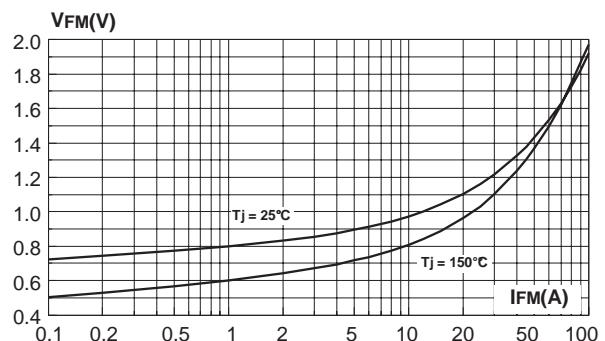


Fig. 5-2 : Peak forward voltage drop versus peak forward current (typical values) - (DIODE D1).

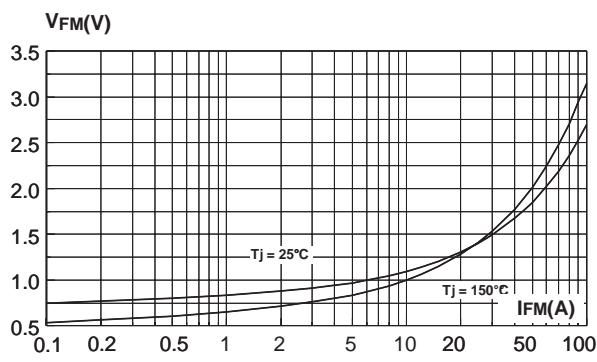
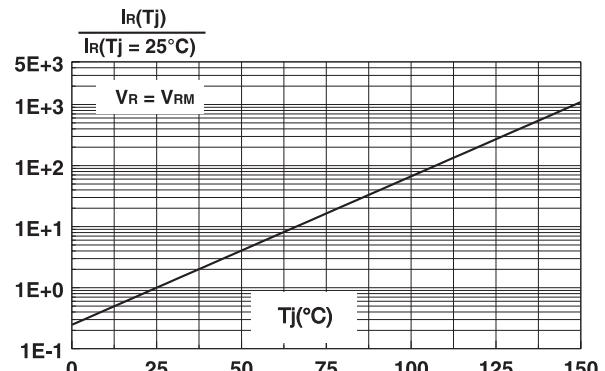
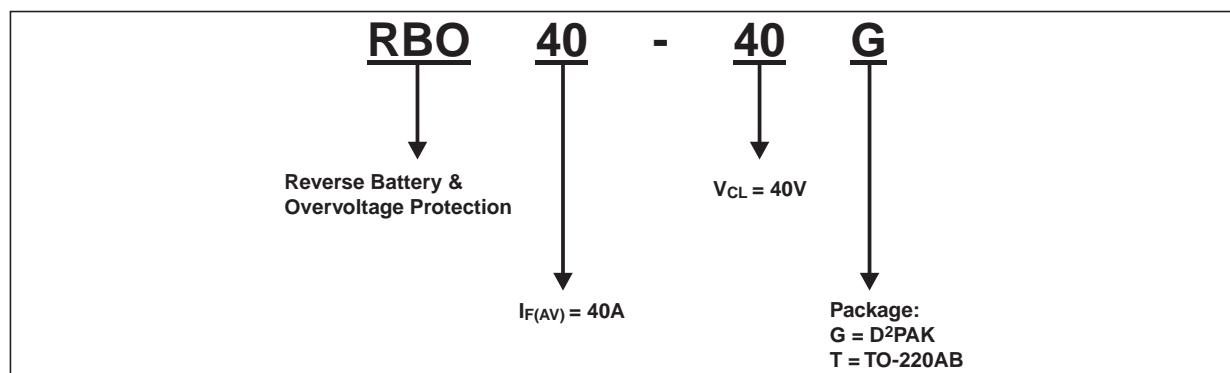


Fig. 6 : Relative variation of leakage current versus junction temperature.

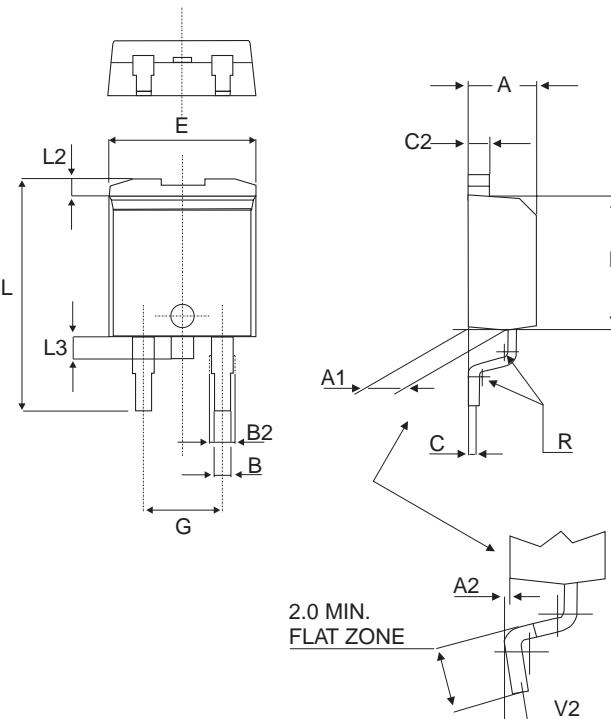


ORDERING INFORMATION



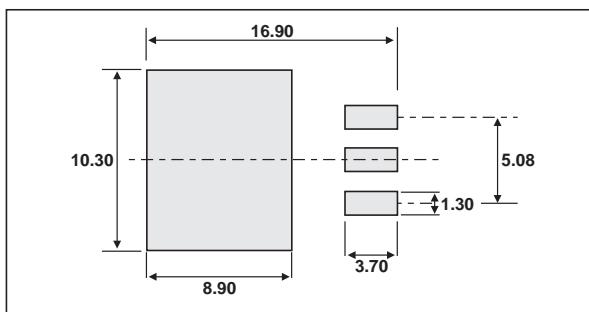
PACKAGE MECHANICAL DATA

D²PAK Plastic



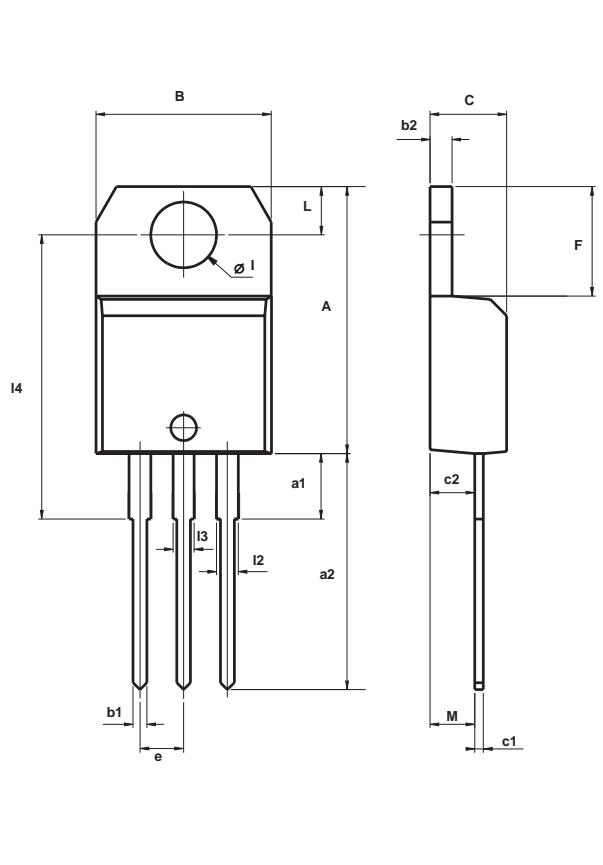
REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.70		0.93	0.027		0.037
B2		1.40			0.055	
C	0.45		0.60	0.017		0.024
C2	1.21		1.36	0.047		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.28	0.393		0.405
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.40		1.75	0.055		0.069
R		0.40			0.016	
V2	0°		8°	0°		8°

FOOT-PRINT (in millimeters)
D²PAK



RBO40-40G / RBO40-40T

PACKAGE MECHANICAL DATA TO-220AB Plastic



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
I	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	

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